Certificate IATF 0369489 Certificate SGS TW11/10513.02

The management system of

Kunshan Sino Silicon Technology Co., Ltd.

No. 303, Hanpu Road, Chengbei, Kunshan, Jiangsu, China

has been assessed and certified as meeting the requirements of

IATF 16949:2016

Edition 1

For the following activities

Manufacture of Silicon Wafers and Silicon Polished Wafers

EXCLUSIONS: 8.3 product Design

3 Year certification is valid from 15 July 2020 until 14 July 2023 and remains valid subject to satisfactory surveillance audits.

Version no. 08 Current version updated 15 July 2020

Authorised by

Veto Power Authority

Contracted Office: SGS United Kingdom Ltd, Station Road, Oldbury, B69 4LN, UK. E-mail: Neil.Hall@sgs.com

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Additional facilities

Global Wafers Co., Ltd.

No. 8, Industrial East Road 2, Hsinchu Science Park, Hsinchu City, 30075, Taiwan

Summary of Activities

Quality System Management, Process Design, Sales, Finance and Strategic Planning.



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